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102 6, 40, 465
1. A method of modifying a thermal barrier assembly comprising a channel,
said method comprising:

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exposing a surface of said channel to a plasma comprising metal moieties;

5 and

depositing said metal moieties on the surface of said channel.

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2. The method of claim 1, wherein said channel comprises a surface treatment
prior to said depositing step, said method further comprising removing at least a portion of
10 said surface treatment from said channel.

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3. The method of claim 1, wherein said metal is selected from the group
consisting of aluminum, nickel, chromium, iron, graphite, molybdenum, copper, cobalt,
tungsten, indium, manganese, zirconium, zinc, cesium, yttrium, antimony, and oxides,
15 carbides, nitrides and silicides thereof, and alloys and mixtures thereof.

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103, 11, 12, 23, 26, 74, 37
4. The method of claim 1, wherein said thermal barrier assembly comprises a
structure selected from the group consisting of a window casing, door casing and curtain
wall.

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20 5. The method of claim 1, wherein said depositing comprises forming a metal
coating on the surface of said channel.

107 2317
25 6. The method of claim 1, wherein said coating has a thickness of no greater
than about 2 mm.

102 do 24, 37
7. The method of claim 1, wherein said channel is defined by a substrate
comprising metal.

107 per vol do 23, 34
30 8. The method of claim 7, wherein said metal is aluminum.

107 not actually
Sub 103

9. The method of claim 1, wherein said channel is defined by a substrate comprising a polymer.

107 design

10. The method of claim 1, wherein said channel comprises a first side wall, a second side wall positioned parallel to said first side wall and spaced no greater than about 2.5 cm from said first side wall.

107 not design

11. The method of claim 1, wherein said thermal barrier assembly comprises a window casing.

107 not design

12. The method of claim 1, wherein said thermal barrier assembly comprises a door casing.

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13. A thermal barrier assembly comprising:
a channel comprising a layer of metal bonded to a surface of said channel, said metal having been deposited onto said channel surface from a plasma.

Sub 103

14. The thermal barrier assembly of claim 13, further comprising an adhesive composition bonded to the modified surface of said channel.

15. The thermal barrier assembly of claim 14, wherein said adhesive composition comprises polyurethane.

16. The thermal barrier assembly of claim 14, wherein said adhesive composition exhibits no greater than 5 % shrinkage when bonded to said surface and subjected to the % Shrinkage Test Method.

17. The thermal barrier assembly of claim 14, wherein said adhesive composition exhibits no greater than 1% shrinkage when bonded to said surface and subjected to the % Shrinkage Test Method.

18. The thermal barrier assembly of claim 14, wherein said adhesive composition exhibits a shear strength of at least 2500 psi shear strength at room temperature after being subjected to the Thermal Cycling Method.

19. The thermal barrier assembly of claim 14, wherein said adhesive composition exhibits a shear strength of at least 3000 psi at room temperature after being subjected to the Thermal Cycling Method.

20. The thermal barrier assembly of claim 14, wherein said adhesive composition exhibits a shear strength of at least 7500 psi at room temperature after being subjected to the Thermal Cycling Method.

21. The thermal barrier assembly of claim 13, wherein said metal is selected from the group consisting of aluminum, nickel, chromium, iron, graphite, molybdenum, copper, cobalt, tungsten, indium, manganese, zirconium, zinc, cesium, yttrium, antimony, and oxides, carbides, nitrides and silicides thereof, and alloys and mixtures thereof.

22. The thermal barrier assembly of claim 13, wherein said channel is defined by a substrate comprising metal.

23. The thermal barrier assembly of claim 22, wherein said metal comprises aluminum.

24. The thermal barrier assembly of claim 13, wherein said channel is defined by a substrate comprising a polymer.

25. A window casing comprising the thermal barrier assembly of claim 15.

26. A door casing comprising the thermal barrier assembly of claim 15.

27. A process for making a thermal barrier assembly, said process comprising:

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cont

exposing a surface of a channel of a thermal barrier assembly to a
plasma comprising metal moieties; and
depositing said metal moieties on the surface of said channel.

5 ¹³⁴ 28. The process of claim 27, further comprising contacting the metal surface of
said channel with an adhesive composition.^{11b}

10 ¹ 29. The process of claim 27, wherein prior to said depositing, said channel
comprises a surface treatment disposed on the channel surface, said process further
comprising removing at least a portion of said surface treatment prior to depositing said
metal moieties.

15 ¹ 30. The process of claim 27, wherein said metal is selected from the group
consisting of aluminum, nickel, chromium, iron, graphite, molybdenum, copper, cobalt,
tungsten, indium, manganese, zirconium, zinc, cesium, yttrium, antimony, and oxides,
carbides, nitrides and silicides thereof, and alloys and mixtures thereof.

20 ¹ 31. The process of claim 28, wherein said adhesive composition comprises
polyurethane.

25 ¹ 32. The process of claim 27, wherein said surface treatment is selected from the
group consisting of polyester, melamine, mill finish, conversion coating, primer, paint,
acrylic, polyester, enamel, polyurethane, fluoropolymer, anodic finishes and combinations
thereof.

30 ^{127 pet rub} 33. The process of claim 27, wherein said channel is defined by a substrate
comprising metal.

^{127 pet rub} 34. The process of claim 33, wherein said metal comprises aluminum.

do n 24

35. The process of claim 27, wherein said channel is defined by a substrate comprising a polymer.

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36. A process for making a window casing comprising the process of claim 27.

37. A process for making a door casing comprising the process of claim 27.

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